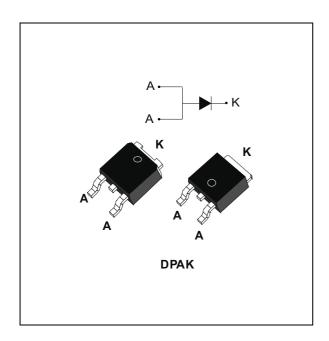




Power Schottky rectifier

Datasheet - production data



Description

High voltage Schottky rectifier suited for switch mode power supply and other power converters.

Packaged in DPAK, this device is intended for use in high frequency circuitries where low switching losses is required.

Table 1. Device summary

Symbol	Value
I _{F(AV)}	10 A
V_{RRM}	45 V
Tj	175 °C
V _{F(typ)}	0.50 V

Features

- Very small conduction losses
- Extremely fast switching
- · Low thermal resistance
- Negligible switching losses
- Low forward voltage drop
- Low capacitance
- Avalanche specification

This is information on a product in full production.

 ECOPACK[®]2 compliant component for DPAK on demand Characteristics STPS1045B

1 Characteristics

Table 2. Absolute ratings (limiting values, at 25 °C unless otherwise stated)

Symbol	Parameter	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage	45	V	
I _{F(RMS)} / pin	Forward rms current	7	Α	
I _{F(AV)}	Average forward current, $\delta = 0.5$, square wave	T _C = 150 °C	10	А
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	75	Α
P _{ARM}	Repetitive peak avalanche power	285	W	
T _{stg}	Storage temperature range	-65 to +175	°C	
T _j	Maximum operating junction temperature ⁽¹⁾	175	°C	

^{1.} $\frac{dPtot}{dT_j} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

Symbol	Parameter	Max. value	Unit
R _{th(j-c)}	Junction to case	3	°C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
L (1) Box	I _R ⁽¹⁾ Reverse leakage current	T _j = 25 °C	$V_R = V_{RRM}$	-		100	μА
'R		T _j = 125 °C		1	7	15	mA
		T _j = 25 °C	I _F = 10 A	-		0.63	
V _F ⁽²⁾ Forward voltage drop	T _j = 125 °C	1F = 10 A	-	0.50	0.57	V	
	Forward voltage drop	T _j = 25 °C	I _F = 20 A	-		0.84	V
		T _j = 125 °C		-	0.65	0.72	

^{1.} Pulse test: $t_p = 5 \text{ ms}$, $\delta < 2\%$

To evaluate the conduction losses, use the following equation:

$$P = 0.42 \text{ x } I_{F(AV)} + 0.015 \text{ x } I_{F}^{2}_{(RMS)}$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2%

STPS1045B Characteristics

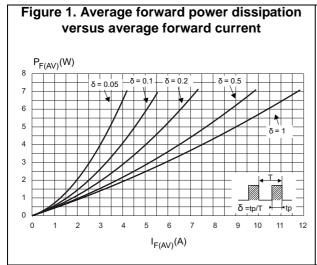


Figure 2. Average forward current versus ambient temperature (δ = 0.5) $I_{F(AV)}(A)$ 12 $R_{th(j-a)} = R_{th(j-c)}$ 10 $R_{th(j-a)} = 70 \text{ °C/W}$ 0 0 25 50 75 100 125 150 175 T_{amb}(°C)

Figure 3. Normalized avalanche power derating versus pulse duration at T_j = 125 °C

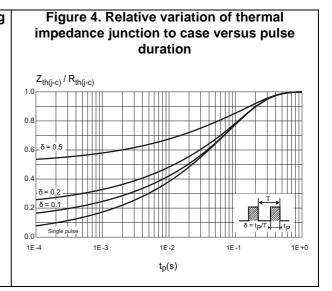
PARM(tp)
PARM(10 µs)

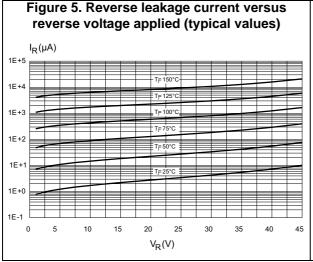
0.01

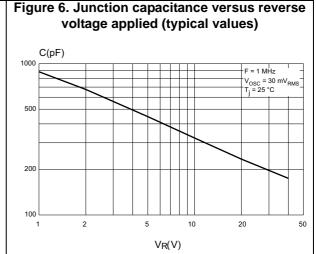
t₂(µs)

100

1000



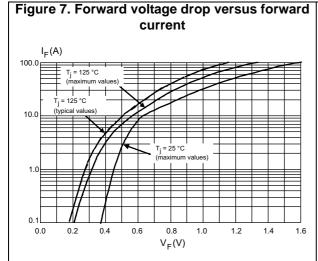


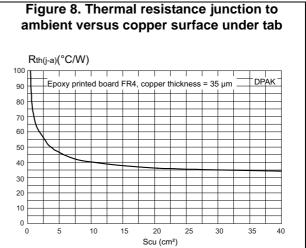


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Characteristics STPS1045B





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Package Information 2

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

2.1 **DPAK** package information

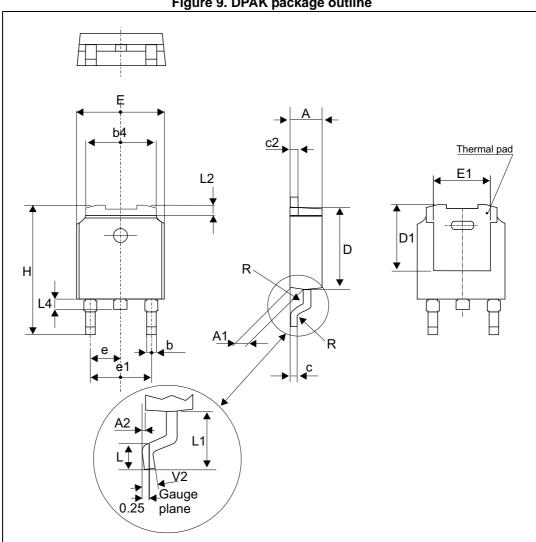


Figure 9. DPAK package outline

Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



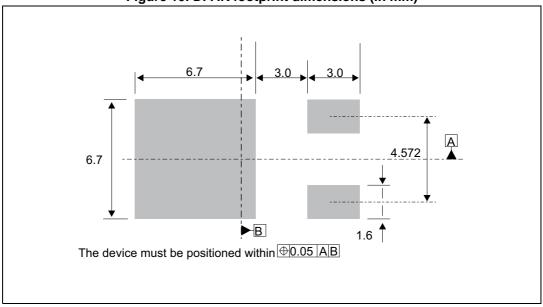
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Package Information STPS1045B

Table 5. DPAK package mechanical data

Dimensions						
Ref.		Millimeters			Inches	
	Min.	Тур.	Max.	Min.	Тур.	Max.
А	2.18		2.40	0.085		0.094
A1	0.90		1.10	0.035		0.043
A2	0.03		0.23	0.001		0.009
b	0.64		0.90	0.025		0.035
b4	4.95		5.46	0.194		0.214
С	0.46		0.61	0.018		0.024
c2	0.46		0.60	0.018		0.023
D	5.97		6.22	0.235		0.244
D1	4.95		5.60	0.194		0.220
Е	6.35		6.73	0.250		0.264
E1	4.32		5.50	0.170		0.216
е		2.28			0.090	
e1	4.40		4.70	0.173		0.185
Н	9.35		10.40	0.368		0.409
L	1.00		1.78	0.039		0.070
L2			1.27			0.050
L4	0.60		1.02	0.023		0.040
V2	-8°		+8°	-8°		8°

Figure 10. DPAK footprint dimensions (in mm)



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3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode	
STPS1045B	S10 45	DPAK	DDVK	0.30 g	75	Tube
STPS1045B-TR	S10 45		0.30 g	2500	Tape and reel	

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
Jul-2003	3B	Last issue
21-Apr-2005	4	IPAK package removed
03-Nov-2005	5	DPAK foot print dimensions updated.
01-Jul-2010	6	Updated Figure 10 Updated ECOPACK statement.
04-Nov-2014	7	Updated DPAK package information, Table 2 and Figure 5. Removed P_{ARM} ($T_j = 25$ °C).
07-Apr-2015	8	Updated Table 2. Format update to current standard.
05-Oct-2016	9	Updated DPAK package information.

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